



Final Product Change Notification

201803027F01

Issue Date: 11-May-2018
Effective Date: 09-Aug-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Change Category

- | | | | | |
|--|--|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input checked="" type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input checked="" type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

Assembly Site Expansion for 1.2um IDR PLCC 44/52/68 from NXP-ATKL to Amkor Technology Philippines

Description of Change

NXP Semiconductors announces the assembly site expansion for the 1.2um IDR PLCC 44/52/68 package from current NXP-ATKL, Kuala Lumpur, Malaysia, assembly Facility to Amkor Technology Philippines (ATP1), Muntinlupa, Philippines Facility.

Reason for Change

Qualification of Amkor Technology Philippines (ATP1), Muntinlupa, Philippines Assembly Facility is to ensure customer supply assurance.

Identification of Affected Products

For PLCC 44/52/68, the current assembly site marking is (Q) for NXP Semiconductor Kuala Lumpur assembly site and will change to (ZR) for the Subcon Amkor Technology Philippines (ATP1).

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 09-Aug-2018

Anticipated Impact on Form, Fit, Function, Reliability or Quality

There is no change to product form, fit, function, or reliability.

Disposition of Old Products

NXP will reserve the right to ship from both locations based on market demand situation.

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 10-Jun-2018.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name P.J Chen
Position Product Engineer
e-mail address pinjiao.chen@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
MC68HC11E0CFNE2	935309342574	MC68HC11E0CFNE2	8BIT MCU, 512 BYTES RAM	PLCC52	RFS	BL Microcontrollers
MC68HC11E1CFNE3	935318971574	MC68HC11E1CFNE3	8 BIT MCU, 512 BYTES EE	PLCC52	RFS	BL Microcontrollers
MC68HC11E9BCFNE2	935318972574	MC68HC11E9BCFNE2	8BIT MCU,12K BUFFALO ROM	PLCC52	RFS	BL Microcontrollers
MCHC11F1CFNE3	935319098574	MCHC11F1CFNE3	8-BIT MCU,1KRAM,512EE,A/	PLCC68	RFS	BL Microcontrollers
MCHC11F1CFNE2	935309499574	MCHC11F1CFNE2	8-BIT MCU,1KRAM,512EE,A/	PLCC68	RFS	BL Microcontrollers
MCHC11F1CFNE4	935313597574	MCHC11F1CFNE4	8-BIT MCU,1KRAM,512EE,A/	PLCC68	RFS	BL Microcontrollers